

## HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

**Table 1: Main Product Characteristics**

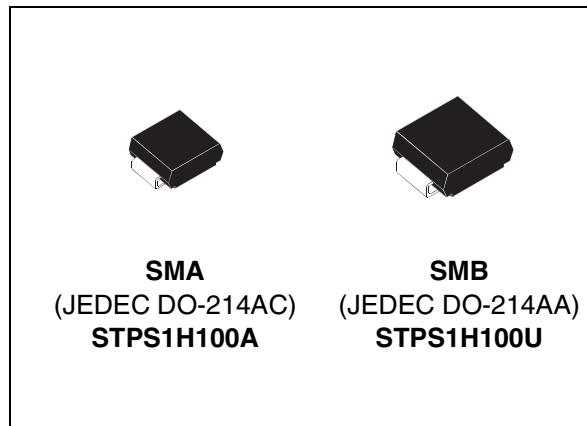
$I_{F(AV)}$	1 A
$V_{RRM}$	100 V
$T_j(\text{max})$	175°C
$V_F(\text{max})$	0.62 V

### FEATURES AND BENEFITS

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche capability specified

### DESCRIPTION

Schottky rectifiers designed for high frequency miniature Switched Mode Power Supplies such as adaptors and on board DC/DC converters.  
Packaged in SMA or SMB.



**Table 2: Order Codes**

Part Number	Marking
STPS1H100A	S11
STPS1H100U	G11

**Table 3: Absolute Ratings (limiting values)**

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	100	V
$I_{F(RMS)}$	RMS forward voltage	10	A
$I_{F(AV)}$	Average forward current	1	A
$I_{FSM}$	Surge non repetitive forward current	50	A
$I_{RRM}$	Repetitive peak reverse current	1	A
$I_{RSM}$	Non repetitive peak reverse current	1	A
$P_{ARM}$	Repetitive peak avalanche power	1500	W
$T_{stg}$	Storage temperature range	-65 to + 175	°C
$T_j$	Maximum operating junction temperature *	175	°C
$dV/dt$	Critical rate of rise of reverse voltage	10000	V/μs

\* :  $\frac{dP_{tot}}{dT_j} > \frac{1}{R_{th}(j-a)}$  thermal runaway condition for a diode on its own heatsink

## STPS1H100

**Table 4: Thermal Resistance**

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to lead	SMA	30
		SMB	25

**Table 5: Static Electrical Characteristics**

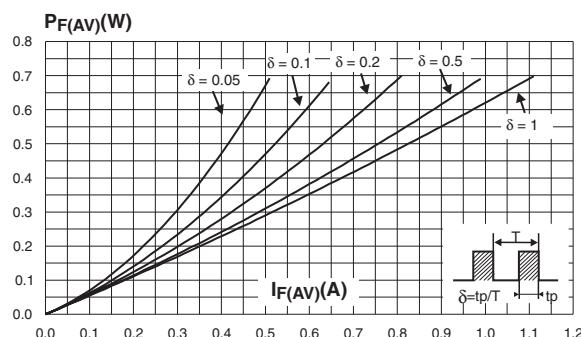
Symbol	Parameter	Tests conditions	Min.	Typ	Max.	Unit
$I_R$ *	Reverse leakage current	$T_j = 25^\circ\text{C}$			4	$\mu\text{A}$
		$T_j = 125^\circ\text{C}$		0.2	0.5	$\text{mA}$
$V_F$ **	Forward voltage drop	$T_j = 25^\circ\text{C}$			0.77	$\text{V}$
		$T_j = 125^\circ\text{C}$		0.58	0.62	
		$T_j = 25^\circ\text{C}$			0.86	
		$T_j = 125^\circ\text{C}$		0.65	0.7	

Pulse test: \*  $tp = 5 \text{ ms}, \delta < 2\%$

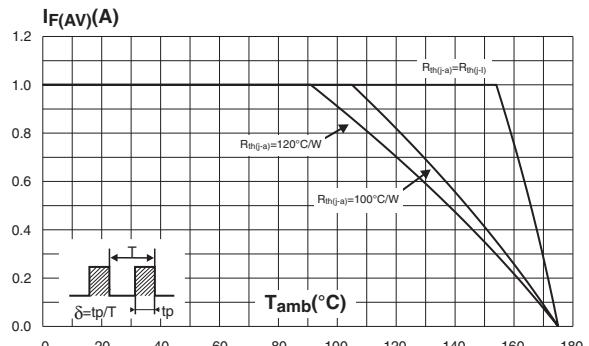
\*\*  $tp = 380 \mu\text{s}, \delta < 2\%$

To evaluate the conduction losses use the following equation:  $P = 0.54 \times I_F(\text{AV}) + 0.08 I_F^2 (\text{RMS})$

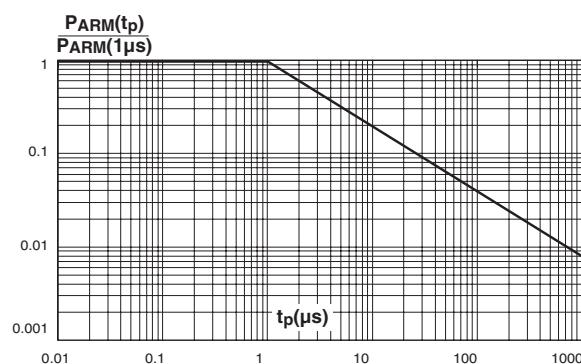
**Figure 1: Average forward power dissipation versus average forward current**



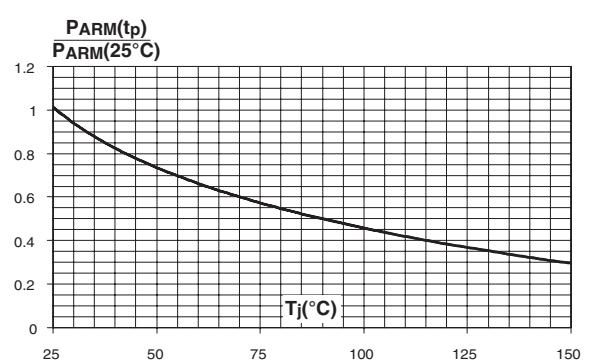
**Figure 2: Average forward current versus ambient temperature ( $\delta = 0.5$ )**



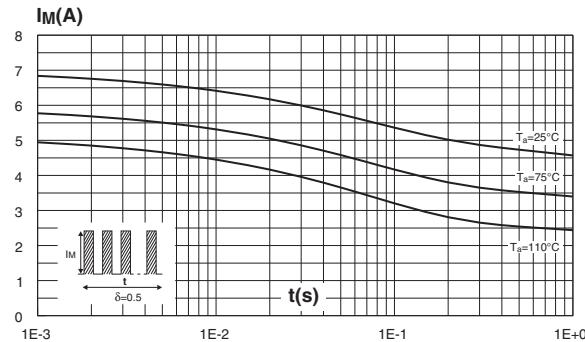
**Figure 3: Normalized avalanche power derating versus pulse duration**



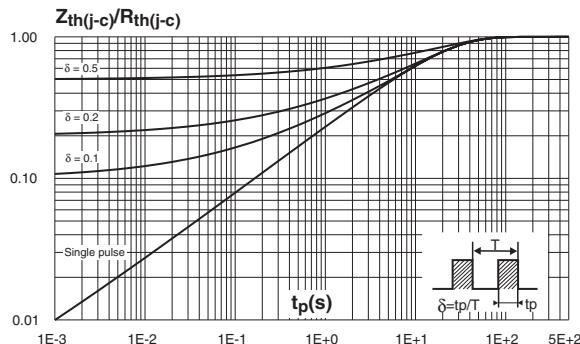
**Figure 4: Normalized avalanche power derating versus junction temperature**



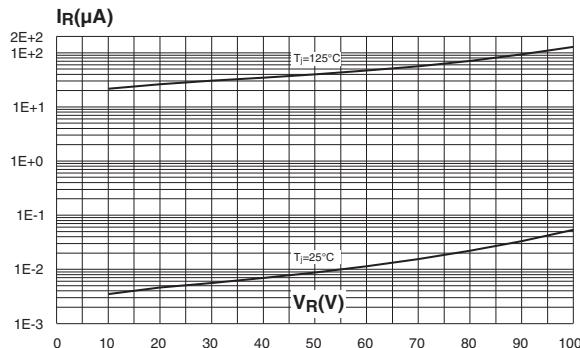
**Figure 5: Non repetitive surge peak forward current versus overload duration (maximum values) (SMA)**



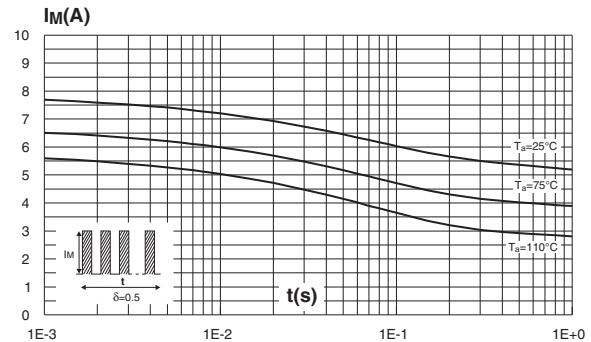
**Figure 7: Relative variation of thermal impedance junction to ambient versus pulse duration (epoxy printed circuit board,  $e(Cu)=35\mu m$ , recommended pad layout) (SMA)**



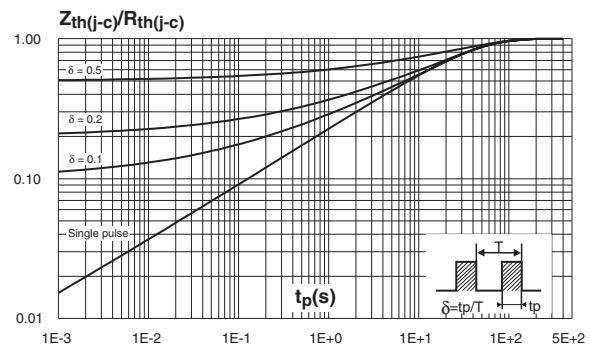
**Figure 9: Reverse leakage current versus reverse voltage applied (typical values)**



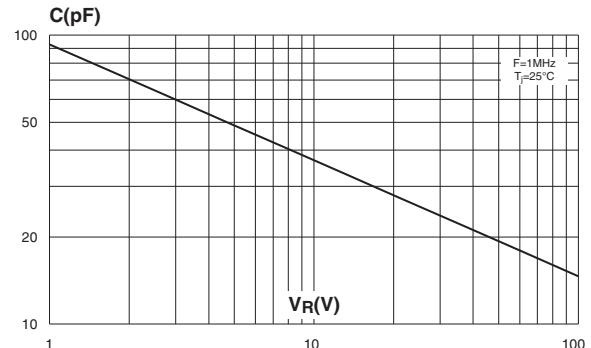
**Figure 6: Non repetitive surge peak forward current versus overload duration (maximum values) (SMB)**



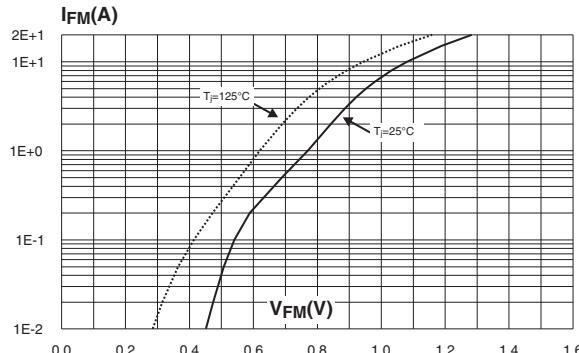
**Figure 8: Relative variation of thermal impedance junction to ambient versus pulse duration (epoxy printed circuit board,  $e(Cu)=35\mu m$ , recommended pad layout) (SMB)**



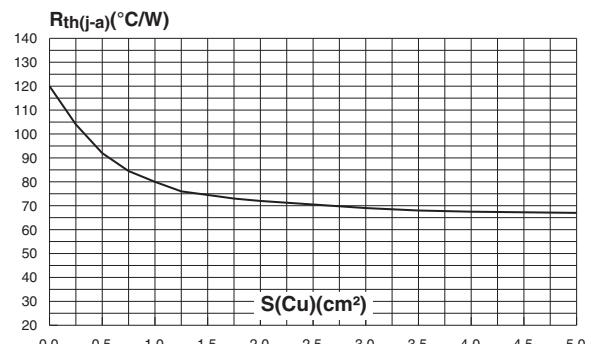
**Figure 10: Junction capacitance versus reverse voltage applied (typical values)**



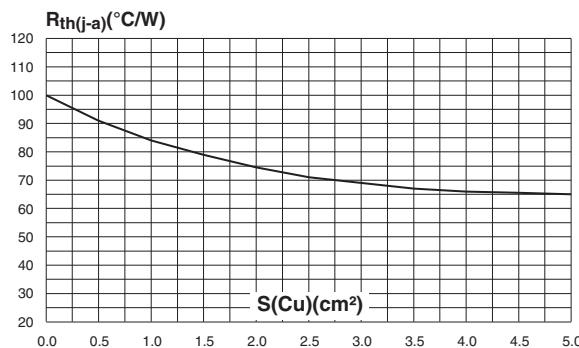
**Figure 11: Forward voltage drop versus forward current (maximum values)**



**Figure 12: Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, copper thickness: 35 $\mu$ m) (SMA)**

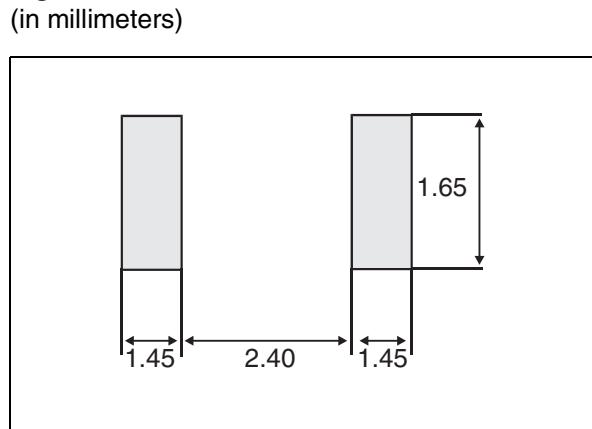


**Figure 13: Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, copper thickness: 35 $\mu$ m) (SMB)**



**Figure 14: SMA Package Mechanical Data**

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.03	0.075	0.080
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.41	0.006	0.016
E	4.80	5.60	0.189	0.220
E1	3.95	4.60	0.156	0.181
D	2.25	2.95	0.089	0.116
L	0.75	1.60	0.030	0.063

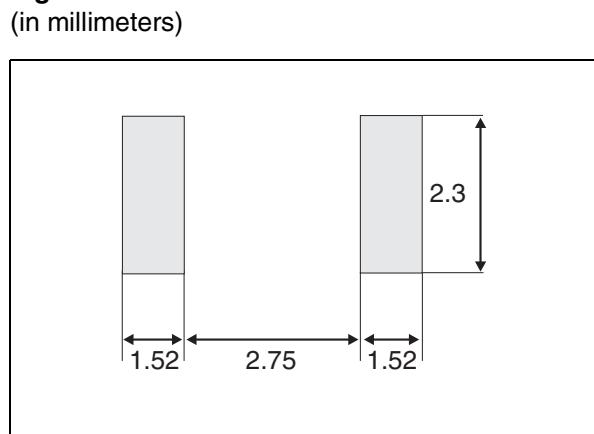
**Figure 15: SMA Foot Print Dimensions**

## STPS1H100

Figure 16: SMB Package Mechanical Data

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.41	0.006	0.016
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
D	3.30	3.95	0.130	0.156
L	0.75	1.60	0.030	0.063

Figure 17: SMB Foot Print Dimensions



**Table 6: Ordering Information**

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS1H100A	S11	SMA	0.068 g	5000	Tape & reel
STPS1H100U	G11	SMB	0.107 g	2500	Tape & reel

- Band indicates cathode
- Epoxy meets UL94, V0

**Table 7: Revision History**

Date	Revision	Description of Changes
Jul-2003	4A	Last update.
Aug-2004	5	SMA package dimensions update. Reference A1 max. changed from 2.70mm (0.106inc.) to 2.03mm (0.080).

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